

General Description

These N-Channel enhancement mode power field effect transistors uses advanced trench Technology, which provides low on-state resistance, high switching performance and excellent quality. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supplies, DC-AC converters for uninterrupted power supplies and motor controls.

Features

- 100% avalanche tested
- Fast Switching
- Improved dv/dt capability

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	150	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D@T_C=25^\circ\text{C}$	Continuous Drain Current	20	A
$I_D@T_C=100^\circ\text{C}$	Continuous Drain Current	14	A
I_{DM}	Pulsed Drain Current	60	A
EAS	Single Pulse Avalanche Energy ¹	150	mJ
$P_D@T_C=25^\circ\text{C}$	Total Power Dissipation	80	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

* Drain current limited by maximum junction temperature.

Thermal Data

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	62	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance Junction-case	2.2	$^\circ\text{C/W}$

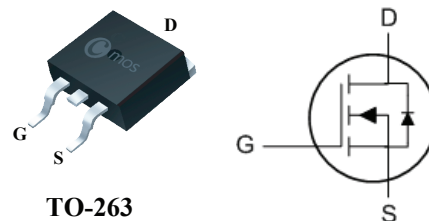
Product Summary

BVDSS	RDSON	ID
150V	110m Ω	20A

Applications

- Switch mode power supplies (SMPS)
- PWM Motor Controls
- DC-DC converters

TO-263 Pin Configuration



Type	Package	Marking
CMB20N15	TO-263	CMB20N15

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V$, $I_D=250\mu A$	150	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V$, $I_D=20A$	---	---	110	$m\Omega$
		$V_{GS}=4.5V$, $I_D=10A$	---	---	115	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250\mu A$	1	---	3	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=120V$, $V_{GS}=0V$, $T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{DS}=120V$, $V_{GS}=0V$, $T_J=125^\circ\text{C}$	---	---	100	
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{DS}=15V$, $I_D=10A$	---	15	---	S
Q_g	Total Gate Charge	$I_D=18A$	---	9	---	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=75V$	---	4	---	
Q_{gd}	Gate-Drain Charge	$V_{GS}=10V$	---	1.5	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DS}=75V$	---	9	---	ns
T_r	Rise Time	$V_{GS}=10V$	---	7	---	
$T_{d(off)}$	Turn-Off Delay Time	$R_L=7.5\Omega$	---	15	---	
T_f	Fall Time	$R_{GEN}=3\Omega$	---	3	---	
C_{iss}	Input Capacitance	$V_{DS}=25V$, $V_{GS}=0V$, $f=1\text{MHz}$	---	1500	---	pF
C_{oss}	Output Capacitance		---	60	---	
C_{rss}	Reverse Transfer Capacitance		---	3.5	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	$V_G=V_D=0V$, Force Current	---	---	20	A
I_{SM}	Pulsed Source Current		---	---	60	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V$, $I_S=19A$, $T_J=25^\circ\text{C}$	---	---	1.2	V

Note :

1. The EAS data shows Max. rating . The test condition is $V_{DD}=50V$, $V_{GS}=10V$, $L=10\text{mH}$, $I_{AS}=5.4A$

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